

## PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3383666

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YING-NAN WEN	05/21/2015
CHIEN-HUNG LIU	05/21/2015
HO-YIN YIU	05/21/2015
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	XINTEC INC.
<b>Street Address:</b>	9F., NO. 23, JILIN RD.
<b>Internal Address:</b>	ZHONGLI DIST.
<b>City:</b>	TAOYUAN CITY
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	320
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14638219
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(213)830-5741
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	(213) 830-5743
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<b>Correspondent Name:</b>	WEN LIU
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<b>ATTORNEY DOCKET NUMBER:</b>	1314/232A
<b>NAME OF SUBMITTER:</b>	WEN LIU
<b>SIGNATURE:</b>	/Wen Liu, Reg. No. 32,822/
<b>DATE SIGNED:</b>	06/04/2015
<b>Total Attachments: 2</b>	
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**ASSIGNMENT**

This assignment agreement is applicable to an invention entitled (Invention Title) \_\_\_\_\_  
**CHIP PACKAGE AND METHOD OF MANUFACTURING THE SAME**

The PATENT RIGHTS referred to in this agreement are:

(check one) ☐ a patent application for this invention, executed by the ASSIGNOR(S) concurrently with this assignment.

☒ U.S. patent application Serial No. 14/638,219, filed March 4, 2015

☐ a U.S. patent application based on PCT International Application

No. \_\_\_\_\_ filed on (date) \_\_\_\_\_ (U.S. patent application Serial No. \_\_\_\_\_, if known).

☐ U.S. patent No. \_\_\_\_\_, issued \_\_\_\_\_.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) ☒ U.S. patent rights only.

☐ Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) Xintec Inc.

(Address) 9F., No.23, Jilin Rd., Zhongli Dist., Taoyuan City 320, Taiwan, R.O.C.

The ASSIGNEE is:

(check one) ☐ An individual.

☐ A Partnership.

☒ A Corporation of TAIWAN, R.O.C. (specify state or country)

☐ (other) \_\_\_\_\_

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO  
 ASSIGNEE: Xintec Inc.


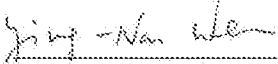
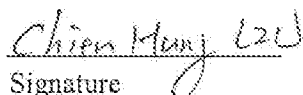
INVENTION TITLE:

CHIP PACKAGE AND METHOD OF MANUFACTURING THE SAME

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

<u>Ho-Yin YIU</u>	<u></u>	<u>2015/5/21</u>
Name of third inventor	Signature	Date
<u>Ying-Nan WEN</u>	<u></u>	<u>2015/5/21</u>
Name of first inventor	Signature	Date
<u>Chien-Hung LIU</u>	<u></u>	<u>2015/5/21</u>
Name of second inventor	Signature	Date